

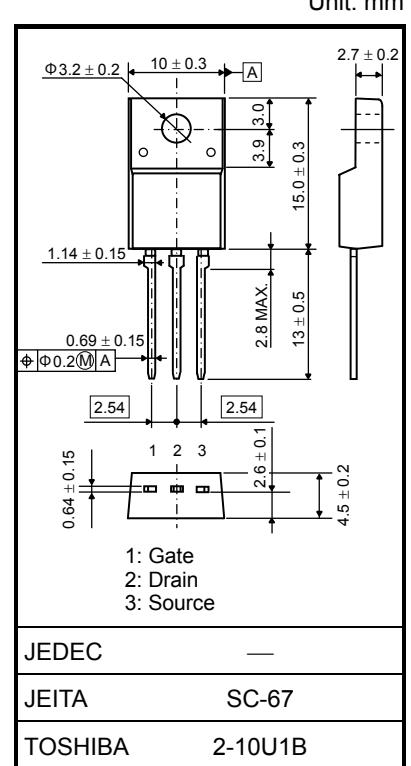


**TK8A50DA**  
Switching Regulator Applications

- Low drain-source ON-resistance:  $R_{DS\ (ON)} = 0.76\ \Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 4.1\ S$  (typ.)
- Low leakage current:  $I_{DSS} = 10\ \mu A$  (max) ( $V_{DS} = 500\ V$ )
- Enhancement-mode:  $V_{th} = 2.4$  to  $4.4\ V$  ( $V_{DS} = 10\ V$ ,  $I_D = 1\ mA$ )

### Absolute Maximum Ratings ( $T_a = 25^\circ C$ )

Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	500	V
Gate-source voltage		$V_{GSS}$	$\pm 30$	V
Drain current	DC (Note 1)	$I_D$	7.5	A
	Pulse ( $t = 1\ ms$ ) (Note 1)	$I_{DP}$	30	
Drain power dissipation ( $T_c = 25^\circ C$ )		$P_D$	35	W
Single pulse avalanche energy (Note 2)		$E_{AS}$	140	mJ
Avalanche current		$I_{AR}$	7.5	A
Repetitive avalanche energy (Note 3)		$E_{AR}$	3.5	mJ
Channel temperature		$T_{ch}$	150	°C
Storage temperature range		$T_{stg}$	-55 to 150	°C



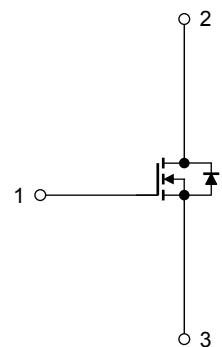
Weight : 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th\ (ch-c)}$	3.57	°C/W
Thermal resistance, channel to ambient	$R_{th\ (ch-a)}$	62.5	°C/W

### Internal Connection



Note 1: Please use devices on conditions that the channel temperature is below 150°C.

Note 2:  $V_{DD} = 90\ V$ ,  $T_{ch} = 25^\circ C$  (initial),  $L = 4.2\ mH$ ,  $R_G = 25\ \Omega$ ,  $I_{AR} = 7.5\ A$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device. Please handle with caution.

**Electrical Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit	
Gate leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±30 V, V <sub>DS</sub> = 0 V	—	—	±1	µA	
Drain cut-off current	I <sub>DSS</sub>	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V	—	—	10	µA	
Drain-source breakdown voltage	V <sub>(BR) DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	500	—	—	V	
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.4	—	4.4	V	
Drain-source ON-resistance	R <sub>DS</sub> (ON)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.8 A	—	0.76	1.04	Ω	
Forward transfer admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 3.8 A	1.0	4.1	—	S	
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz	—	700	—	pF	
Reverse transfer capacitance	C <sub>rss</sub>		—	4	—		
Output capacitance	C <sub>oss</sub>		—	80	—		
Switching time	Rise time	t <sub>r</sub>	 V <sub>GS</sub> 10 V 0 V 50 Ω ID = 3.8 A V <sub>OUT</sub> R <sub>L</sub> = 54 Ω V <sub>DD</sub> ≈ 200 V Duty ≤ 1%, t <sub>W</sub> = 10 µs	—	20	—	ns
	Turn-on time	t <sub>on</sub>		—	40	—	
	Fall time	t <sub>f</sub>		—	11	—	
	Turn-off time	t <sub>off</sub>		—	60	—	
Total gate charge	Q <sub>g</sub>	V <sub>DD</sub> ≈ 400 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7.5 A	—	16	—	nC	
Gate-source charge	Q <sub>gs</sub>		—	10	—		
Gate-drain charge	Q <sub>gd</sub>		—	6	—		

**Source-Drain Ratings and Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	—	—	—	7.5	A
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	—	—	—	30	A
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 7.5 A, V <sub>GS</sub> = 0 V	—	—	-1.7	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 7.5 A, V <sub>GS</sub> = 0 V, dI <sub>DR</sub> /dt = 100 A/µs	—	1200	—	ns
Reverse recovery charge	Q <sub>rr</sub>		—	8.5	—	µC

**Marking**